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UNITED STATES PATENT AND TRADEMARK OFFICE  
**CERTIFICATE OF CORRECTION**

PATENT NO. : 6,806,198 B1  
DATED : October 19, 2004  
INVENTOR(S) : Ring et al.

Page 1 of 1

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

Column 5,

Line 43, "copper" should read -- copper, --.

Column 6,

Claims 22 and 23 are missing:

22. The method of claim 1, further including analyzing the die after supplying sufficient oxygen-containing gas to the die.

23. The method of claim 22, further including obtaining results in response to analyzing the die, and using the obtained results to manufacture additional semiconductor devices.

Signed and Sealed this

Nineteenth Day of April, 2005



JON W. DUDAS  
*Director of the United States Patent and Trademark Office*